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Embedded microprocessors are utilized across a broad spectrum of applications, making them indispensable in

Details

Product Status	Active
Core Processor	Z80180
Number of Cores/Bus Width	1 Core, 8-Bit
Speed	10MHz
Co-Processors/DSP	-
RAM Controllers	DRAM
Graphics Acceleration	No
Display & Interface Controllers	-
Ethernet	-
SATA	-
USB	-
Voltage - I/O	5.0V
Operating Temperature	-40°C ~ 100°C (TA)
Security Features	-
Package / Case	80-BQFP
Supplier Device Package	80-QFP
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8018010feg



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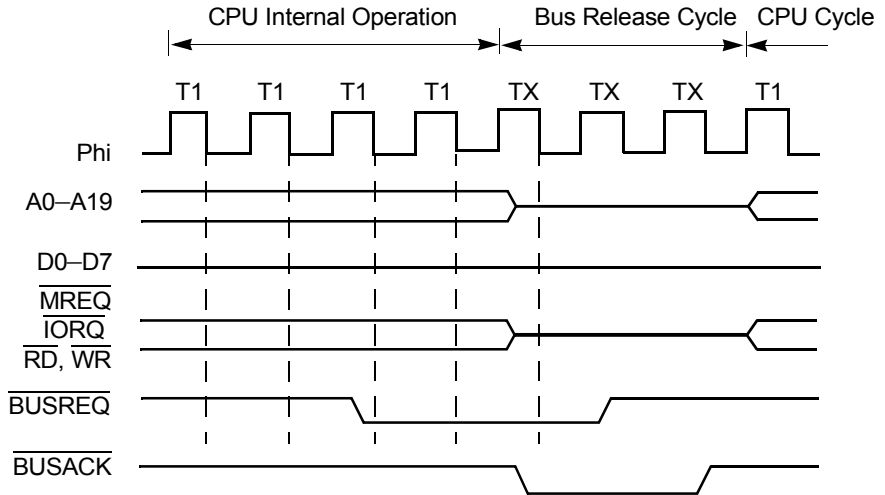


Figure 17. Bus Exchange Timing During CPU Internal Operation

Wait State Generator

To ease interfacing with slow memory and I/O devices, the Z8X180 uses Wait States (TW) to extend bus cycle timing. A Wait State(s) is inserted based on the combined (logical OR) state of the external $\overline{\text{WAIT}}$ input and an internal programmable wait state (TW) generator. Wait States (TW) can be inserted in both CPU execution and DMA transfer cycles.

When the external $\overline{\text{WAIT}}$ input is asserted Low, Wait State(s) (TW) are inserted between T2 and T3 to extend the bus cycle duration. The $\overline{\text{WAIT}}$ input is sampled at the falling edge of the system clock in T2 or TW. If the $\overline{\text{WAIT}}$ input is asserted Low at the falling edge of the system clock in TW, another TW is inserted into the bus cycle.

► **Note:** $\overline{\text{WAIT}}$ input transitions must meet specified setup and hold times. This specification can easily be accomplished by



If the BREXT bit of the CPU Control Register (CCR) is cleared, asserting the $\overline{\text{BUSREQ}}$ does not cause the Z8S180/Z8L180-class processors to exit STANDBY mode.

If STANDBY mode is exited because of a reset or an external interrupt, the Z8S180/Z8L180-class processors remains relinquished from the system bus as long as $\overline{\text{BUSREQ}}$ is active.

STANDBY Mode EXit with External Interrupts

STANDBY mode can be exited by asserting input $\overline{\text{NMI}}$. The STANDBY mode may also exit by asserting $\overline{\text{INT0}}$, $\overline{\text{INT1}}$ or $\overline{\text{INT2}}$, depending on the conditions specified in the following paragraphs.

$\overline{\text{INT0}}$ wake-up requires assertion throughout duration of clock stabilization time (2^{17} clocks).

If exit conditions are met, the internal counter provides time for the crystal oscillator to stabilize, before the internal clocking and the system clock output within the Z8S180/Z8L180-class processors resume.

- Exit with Non-Maskable Interrupts

If $\overline{\text{NMI}}$ is asserted, the CPU begins a normal NMI interrupt acknowledge sequence after clocking resumes.

- Exit with External Maskable Interrupts

If an External Maskable Interrupt input is asserted, the CPU responds according to the status of the Global Interrupt Enable Flag IEF1 (determined by the ITE1 bit) and the settings of the corresponding interrupt enable bit in the Interrupt/Trap Control Register (ITC: I/O Address = 34H).

If an interrupt source is disabled in the ITC, asserting the corresponding interrupt input does not cause the Z8S180/Z8L180-class processors to exit STANDBY mode. This condition is true regardless of the state of the Global Interrupt Enable Flag IEF1.



except that the 2^{17} bit wake-up timer is bypassed. All control signals are asserted eight clock cycles after the exit conditions are gathered.

STANDBY-QUICK RECOVERY Mode

STANDBY-QUICK RECOVERY mode is an option offered in STANDBY mode to reduce the clock recovery time in STANDBY mode from 2^{17} clock cycles (4 μ s at 33 MHz) to 2^6 clock cycles (1.9 μ s at 33 MHz). This feature can only be used when providing an oscillator as clock source.

To enter STANDBY-QUICK RECOVERY mode:

1. Set bits 6 and 3 to 1 and 1, respectively.
2. Set the I/O STOP bit (bit 5 of ICR, I/O Address = 3FH) to 1.
3. Execute the SLEEP instruction

When the part is in STANDBY-QUICK RECOVERY mode, the operation is identical to STANDBY mode except when exit conditions are gathered, using RESET, BUS REQUEST or EXTERNAL INTERRUPTS. The clock and other control signals are recovered sooner than the STANDBY mode.

► **Note:** If STANDBY-QUICK RECOVERY is enabled, the user must ensure stable oscillation is obtained within 64 clock cycles

Internal I/O Registers

The Z8X180 internal I/O Registers occupy 64 I/O addresses (including reserved addresses). These registers access the internal I/O modules (ASCI, CSI/O, PRT) and control functions (DMAC, DRAM refresh, interrupts, wait state generator, MMU and I/O relocation).



Table 7. I/O Address Map (Z8S180/Z8L180-Class Processors Only) (Continued)

	Register	Mnemonic	Address		
			Binary	Hex	Page
Timer	Data Register Ch 0 L	TMDR0L	XX001100	0CH	159
	Data Register Ch 0 H	TMDR0H	XX001101	0DH	159
	Reload Register Ch 0 L	RLDR0L	XX001110	0EH	159
	Reload Register Ch 0 H	RLDR0H	XX001111	0FH	159
	Timer Control Register	TCR	XX010000	10H	161
	Reserved		XX010001	11H	
	Data Register Ch 1 L	TMDR1L	XX010100	14H	160
	Data Register Ch 1 H	TMDR1H	XX010101	15H	160
	Reload Register Ch 1 L	RLDR1L	XX010110	16H	160
	Reload Register Ch 1 H	RLDR1H	XX010111	17H	160
Others	Free Running Counter Reserved	FRC	XX011000	18H	172
			XX011001	19H	
			↕	↕	
			XX011111	1DH	
	Clock Multiplier Register	CMR	XX011110	1EH	52
	CPU Control Register	CCR	XX011111	1FH	53

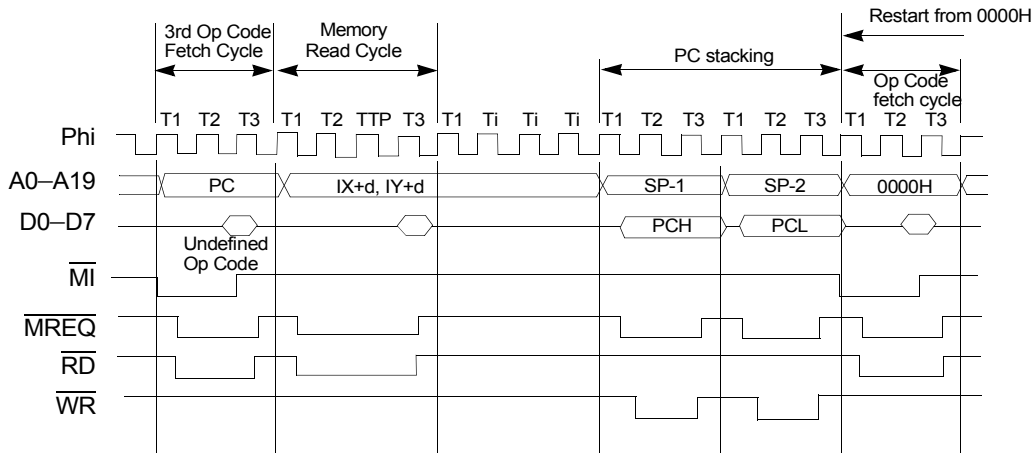


Figure 33. TRAP Timing - 3rd Op Code Undefined

External Interrupts

The Z8X180 features four external hardware interrupt inputs:

- \overline{NMI} —Non-maskable interrupt
- $\overline{INT0}$ —Maskable Interrupt Level 0
- $\overline{INT1}$ —Maskable Interrupt Level 1
- $\overline{INT2}$ —Maskable Interrupt Level 2

\overline{NMI} , $\overline{INT1}$, and $\overline{INT2}$ feature fixed interrupt response modes. $\overline{INT0}$ has 3 different software programmable interrupt response modes—Mode 0, Mode 1 and Mode 2.

\overline{NMI} - Non-Maskable Interrupt

The \overline{NMI} interrupt input is edge-sensitive and cannot be masked by software. When \overline{NMI} is detected, the Z8X180 operates as follows:



Table 14. Transfer Mode Combinations

DM1	DM0	SM1	SM0	Transfer Mode	Increment/Decrement
1	1	0	0	Memory to I/O	SAR0+1, DAR0 fixed
1	1	0	1	Memory to I/O	SAR0-1, DAR0 fixed
1	1	1	0	Reserved	
1	1	1	1	Reserved	

Note: *: includes memory mapped I/O.

DMA/WAIT Control Register (DCNTL)

DCNTL controls the insertion of Wait States into DMAC (and CPU) accesses of memory or I/O. Also, the DMA request mode for each DREQ ($\overline{\text{DREQ0}}$ and $\overline{\text{DREQ1}}$) input is defined as level or edge sense. DCNTL also sets the DMA transfer mode for channel 1, which is limited to memory to/from I/O transfers.



rising edge of the clock prior to T3 at which time the DMA operation (re)starts. Figure 48 depicts the edge-sense DMA timing.

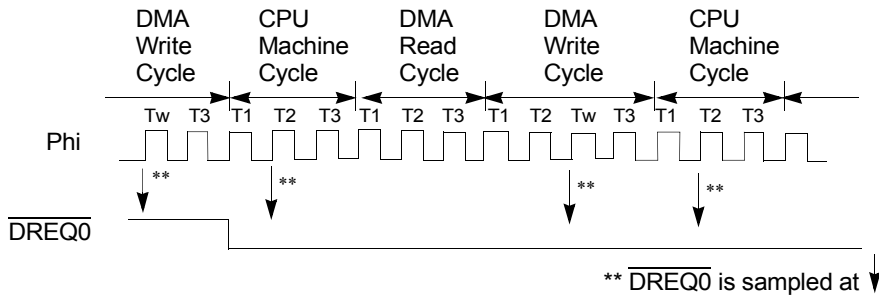


Figure 48. CPU Operation and DMA Operation $\overline{\text{DREQ0}}$ is Programmed for Edge-Sense

During the transfers for channel 0, the $\overline{\text{TEND0}}$ output goes Low synchronous with the write cycle of the last (BCR0 = 00H) DMA transfer (Reference Figure 49).

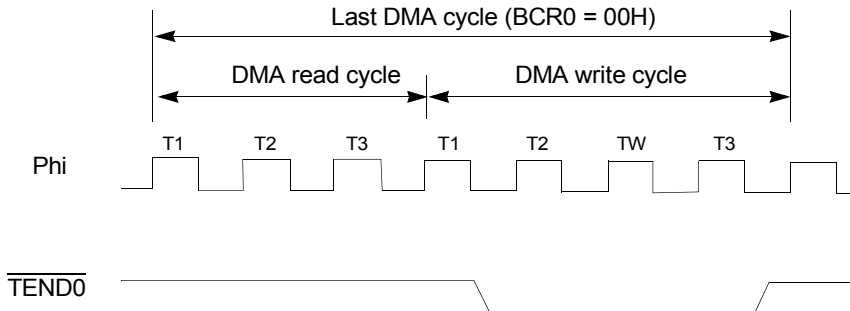


Figure 49. $\overline{\text{TEND0}}$ Output Timing Diagram

The $\overline{\text{DREQ0}}$ and $\overline{\text{TEND0}}$ pins are programmably multiplexed with the CKA0 and CKA1 ASCI clock input/outputs. However, when DMA channel 0 is programmed for memory to/from I/O (and memory to/from



Table 17. Data Formats

MOD2	MOD1	MOD0	Data Format
0	0	0	Start + 7 bit data + 1 stop
0	0	1	Start + 7 bit date + 2 Stop
0	1	0	Start + 7 bit data + parity + 1 stop
0	1	1	Start + 7 bit data + parity + 2 stop
1	0	0	Start + 8 bit data + 1 stop
1	0	1	Start + 8 bit data + 2 stop
1	1	0	Start + 8 bit data + parity + 1 stop
1	1	1	Start + 8 bit date + parity + 2 stop

ASCII Control Register B0, 1 (CNTLB0, 1)

Each ASCII channel control register B configures multiprocessor mode, parity and baud rate selection.



Bit Position	Bit/Field	R/W	Value	Description
0	Send	R/W	0	Normal Xmit
	Break		1	Drive TXA Low

Each ASCII channel control register B configures multiprocessor mode, parity and baud rate selection.

ASCII Extension Control Register (I/O Address: 13H) (Z8S180/L180-Class Processors Only)

Bit	7	6	5	4	3	2	1	0
Bit/Field	RDRF Int Inhibit	Reserved		X1 Bit Clk ASCII	BRG1 Mode	Break Feature Enable	Break Detect (RO)	Send Break
R/W	R/W	?		R/W	R/W	R/W	R/W	R/W
Reset	0	0		0	0	0	0	0

Note: R = Read W = Write X = Indeterminate ? = Not Applicable

Bit Position	Bit/Field	R/W	Value	Description
7	RDRF Interrupt Inhibit	R/W	0	RDRF Interrupt Inhibit On
			1	RDRF Interrupt Inhibit Off
6–5	Reserved	?	0	Reserved. Must be 0
4	X1 Bit Clk ASCII	R/W	0	CKA1 /16 or /64
			1	CKA1 is bit clock
3	BRG1 Mode	R/W	0	As S180
			1	Enable 16-bit BRG counter



ASCI to/from DMAC Operation

Operation of the ASCI with the on-chip DMAC channel 0 requires that the DMAC be correctly configured to use the ASCI flags as DMA request signals.

ASCI and RESET

During RESET, the ASCI status and control registers are initialized as defined in the individual register descriptions.

Receive and Transmit operations are stopped during RESET. However, the contents of the transmit and receive data registers (TDR and RDR) are not changed by RESET.

ASCI Clock

When in external clock input mode, the external clock is directly input to the sampling rate ($\div 16/\div 64$) as depicted in Figure 56.

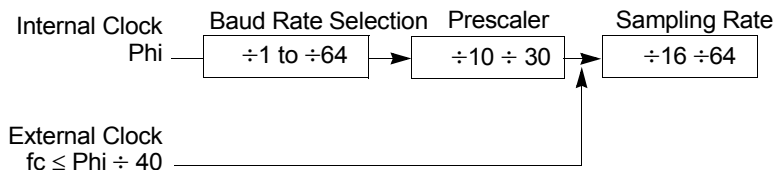


Figure 56. ASCII Clock



- c. Poll the RE bit in CNTR until RE = 0.
 - d. Read the receive data from TRDR.
 - e. Repeat steps 2 to 4 for each receive data byte.
- Receive–Interrupts
 - a. Poll the RE bit in CNTR until RE is 0.
 - b. Set the RE and EIE bits in CNTR to 1.
 - c. When the receive interrupt occurs read the receive data from TRDR.
 - d. Set the RE bit in CNTR to 1.
 - e. Repeat steps 3 and 4 for each receive data byte.

CSI/O Operation Timing Notes

- Transmitter clocking and receiver sampling timings are different from internal and external clocking modes. Figure 59 to Figure 62 illustrate CSI/O Transmit/Receive Timing.
- The transmitter and receiver is disabled TE and RE = 0) when initializing or changing the baud rate.

CSI/O Operation Notes

- Disable the transmitter and receiver (TE and RE = 0) before initializing or changing the baud rate. When changing the baud rate after completion of transmission or reception, a delay of at least one bit time is required before baud rate modification.
- When RE or TE is cleared to 0 by software, a corresponding receive or transmit operation is immediately terminated. Normally, TE or RE is only cleared to 0 when EF is 1.
- Simultaneous transmission and reception is not possible. Thus, TE and RE are not both 1 at the same time.

Table 23. Timer Output Control

TOC1	TOC0	OUTPUT
0	0	Inhibited (A18/TOUT pin is selected as an address output function.)
0	1	Toggled
1	0	0 A18/TOUT pin is selected as a PRT1 output function!
1	1	1

Figure 64 illustrates timer initialization, count down, and reload timing. Figure 65 depicts timer output (A18/TOUT) timing.

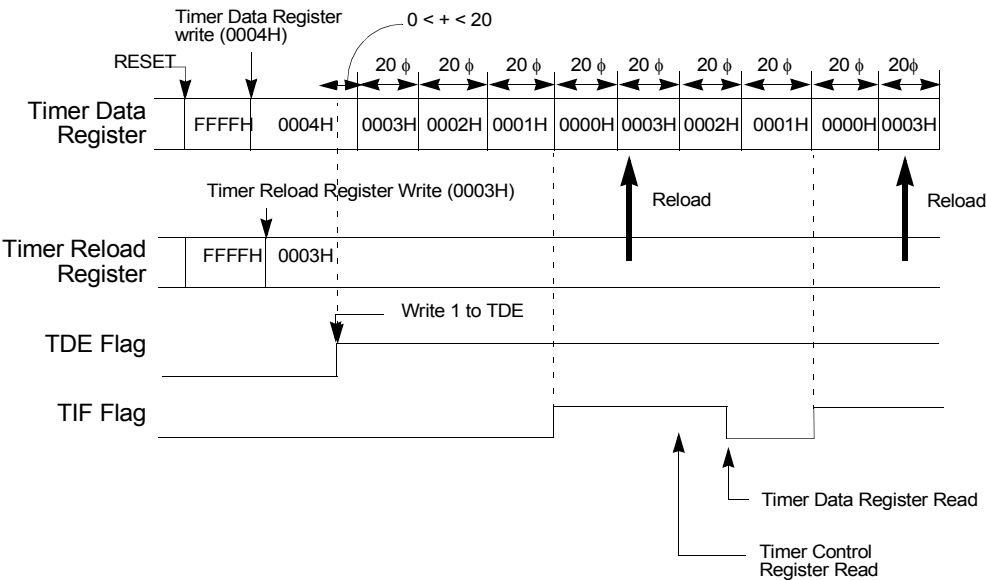


Figure 64. Timer Initialization, Count Down, and Reload Timing Diagram



These devices require connection with the Z8X180 synchronous E clock output. The speed (access time) required for the peripheral devices are determined by the Z8X180 clock rate. Table 24, and Figure 67 through Figure 70 define E clock output timing.

Wait States are inserted in Op Code fetch, memory read/write, and I/O read/write cycles which extend the duration of E clock output High. During I/O read/write cycles with no Wait States (only occurs during on-chip I/O register accesses), E does not go High.

Table 24. E Clock Timing in Each Condition

Condition	Duration of E Clock Output High	
Op Code Fetch Cycle Memory Read/Write Cycle	T2 rise - T3 fall	$(1.5 \Phi + nw \times \Phi)$
I/O read Cycle	1st Tw rise - T3 fall	$(0.5\Phi + nw \times \Phi)$
I/O Write Cycle	1st Tw rise - T3 rise	$In_w \times \Phi$
\overline{NMI} Acknowledge 1st MC	T2 rise - T3 fall	(1.5Φ)
$\overline{INT0}$ Acknowledge 1st MC	1st Tw rise - T3 fall	$(0.50 + nw \times \Phi)$
BUS RELEASE mode SLEEP mode SYSTEM STOP mode	Φ fall - Φ fall	$(2 \Phi \text{ or } 1 \Phi)$
Note: nw = the number of Wait States; MC: Machine Cycle		



IO (I/O)

IO addressing mode is used only by I/O instructions. This mode specifies I/O address ($\overline{\text{IORQ}}$ is 0) and outputs them as follows.

1. An operand is output to A0–A7. The contents of accumulator is output to A8–A15.
2. The contents of Register B is output to A0–A7. The contents of Register C is output to A8–A15.
3. An operand is output to A0–A7. 00H is output to A8–A15 (useful for internal I/O register access)
4. The contents of Register C is output to A0–A7. 00H is output to A8–A15 (useful for internal I/O register access).



DATA MANIPULATION INSTRUCTIONS

Table 38. Arithmetic and Logical Instructions (8-bit)

Operation Name	Mnemonics	Op Code	Addressing							Bytes	States	Operation	Flags					
													7	6	4	2	1	0
			Immed	Ext	Ind	Reg	Regl	Imp	Rel				S	Z	H	P/V	N	C
ADD	ADD A,g	10 000 g				S		D		1	4	$Ar + gr \rightarrow Ar$	↑	↑	↑	V	R	↑
	ADD A, (HL)	10 000 110					S	D		1	6	$Ar + (HL)_M \rightarrow Ar$	↑	↑	↑	V	R	↑
	ADD A, m	11 000 110	S					D		2	6	$Ar + m \rightarrow Ar$	↑	↑	↑	V	R	↑
	<m>																	
	ADD A,(IX + d)	11 011 101			S			D		3	14	$Ar + (IX + d)_M \rightarrow Ar$	↑	↑	↑	V	R	↑
	<d>	10 000 110																
	ADD A,(IY + d)	11 111 101			S			D		3	14	$Ar + (IY + d)_M \rightarrow Ar$	↑	↑	↑	V	R	↑
ADC	ADC A,g	10 001 g				S		D		1	4	$Ar + gr + c \rightarrow Ar$	↑	↑	↑	V	R	↑
	ADC A,(HL)	10 001 110					S	D		1	6	$Ar + (HL)_M + c \rightarrow Ar$	↑	↑	↑	V	R	↑
	ADC A,m	11 001 110	S					D		2	6	$Ar + m + c \rightarrow Ar$	↑	↑	↑	V	R	↑
	<m>																	
	ADC A,(IX + d)	11 011 101			S			D		3	14	$Ar + (IX + d)_M + c \rightarrow Ar$	↑	↑	↑	V	R	↑
	<d>	10 001 110																
	ADC A,(IY + d)	11 111 101			S			D		3	14	$Ar + (IY + d)_M + c \rightarrow Ar$	↑	↑	↑	V	R	↑
	<d>	10 001 110																
	<d>																	



Table 51. Bus and Control Signal Condition in Each Machine Cycle (Continued)

Instruction	Machine Cycle	States	Address	Data	\overline{RD}	\overline{WR}	\overline{MREQ}	\overline{IORQ}	\overline{MI}	\overline{HALT}	ST
LD (mn),A	MC1	T1T2T3	1st Op Code Address	1st Op Code	0	1	0	1	0	1	0
	MC2	T1T2T3	1st operand Address	n	0	1	0	1	1	1	1
	MC3	T1T2T3	2nd operand Address	m	0	1	0	1	1	1	1
	MC4	Ti	*	Z	1	1	1	1	1	1	1
	MC5	T1T2T3	mn	A	1	0	0	1	1	1	1
LD A,I LD A,R LD I,A LD R,A	MC1	T1T2T3	1st Op Code Address	1st Op Code	0	1	0	1	0	1	0
	MC2	T1T2T3	2nd Op Code Address	2nd Op Code	0	1	0	1	0	1	1
LD ww, mn	MC1	T1T2T3	1st Op Code Address	1st Op Code	0	1	0	1	0	1	0
	MC2	T1T2T3	1st operand Address	n	0	1	0	1	1	1	1
	MC3	T1T2T3	2nd operand Address	m	0	1	0	1	1	1	1
LD IX,mn LD IY,mn	MC1	T1T2T3	1st Op Code Address	1st Op Code	0	1	0	1	0	1	0
	MC2	T1T2T3	2nd Op Code Address	2nd Op Code	0	1	0	1	0	1	1
	MC3	T1T2T3	1st operand Address	n	0	1	0	1	1	1	1
	MC4	T1T2T3	2nd operand Address	m	0	1	0	1	1	1	1
*4 In the case of R1 and Z MASK, interrupt request is not sampled.											



Table 52. Interrupts (Continued)

Instruction	Machine Cycle	States	Address	Data	\overline{RD}	\overline{WR}	\overline{MREQ}	\overline{IORQ}	\overline{MI}	\overline{HALT}	ST
$\overline{INT0}$ Mode 2	MC1	TIT2TW TWT3	Next Op Code Address (PC)	Vector	1	1	1	0	0	1	0
	MC2	Ti	*	Z	1	1	1	1	1	1	1
	MC3	TIT2T3	SP-1	PCH	1	0	0	1	1		1
	MC4	TIT2T3	SP-2	PCL	1	0	0	1	1	1	1
	MC5	TIT2T3	I, Vector	DATA	0	1	0	1	1	1	1
	MC6	TIT2T3 TIT2,TW	I, Vector+1	DATA	0	1	0	1	1	1	1
$\overline{INT1}$ $\overline{INT2}$ Internal Interrupts	MC1	TIT2,TW TWT3	Next Op Code Address (PC)		1	1	1	1	1	1	0
	MC2	Ti	*	Z	1	1	1	1	1	1	1
	MC3	TIT2T3	SP-1	PCH	1	0	0	1	1	1	1
	MC4	TIT2T3	SP-2	PCL	1	0	0	1	1	1	1
	MC5	TIT2T3	I, Vector	DATA	0	1	0	1	1	1	1
	MC6	TIT2T3	I, Vector+1	DATA	0	1	0	1	1	1	1



Table 55. Pin Outputs in Each Operating Mode (Continued)

Mode		$\overline{\text{MI}}$	$\overline{\text{MREQ}}$	$\overline{\text{IORQ}}$	$\overline{\text{RD}}$	$\overline{\text{WR}}$	$\overline{\text{RFSH}}$	$\overline{\text{HALT}}$	$\overline{\text{BUSACK}}$	ST	Address BUS	Data BUS
Internal DMA	Memory Read	1	0	1	0	1	1	*	1	0	A	IN
	Memory Write	1	0	1	1	0	1	*	1	0	A	OUT
	I/O Read	1	1	0	0	1	1	*	1	0	A	IN
	I/O Write	1	1	0	1	0	1	*	1	0	A	OUT
RESET		1	1	1	1	1	1	1	1	1	Z	IN

- 1 : High
- 0 : Low
- A : Programmable
- Z : High Impedance
- IN : Input
- OUT : Output
- * : Invalid

PIN STATUS

Tables 56 describes the status of each ping during RESET and LOW POWER OPERATION modes.



Table 56. Pin Status During RESET and LOW POWER OPERATION Modes (Continued)

Symbol	Pin Function	Pin Status in Each Operation Mode			
		RESET	SLEEP	IOSTOP	SYSTEM STOP
$\overline{\text{MREQ}}$	—	1	1	OUT	1
E	—	0	E Clock Output	←	←
$\overline{\text{MI}}$	—	1	1	OUT	1
$\overline{\text{WR}}$	—	1	1	OUT	1
$\overline{\text{RD}}$	—	1	1	OUT	1
Phi	—	Phi Clock Output	←	←	←

- 1: HIGH 0: LOW A: Programmable Z: High Impedance
- IN (A): Input (Active) IN (N): Input (Not active) OUT: Output
- H: Holds the previous state
- ←: same as the left